

03-06-2003



FORM PTO-1595

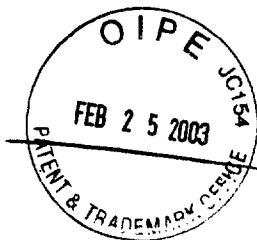
U.S. Department of Commerce
Patent and Trademark Office

TI-34307

102381927

To the Assistant Commissioner for Patents. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Richard L. Guldi 1/21/03
Karanpreet Chahal 1/29/03

2. Name and Address of receiving party(ies):

Name: TEXAS INSTRUMENTS INCORPORATED

Address: P.O. Box 655474, MS 3999

City: Dallas

State: TX Zip: 75265

Additional name(s) & address(es) attached? ___ Yes ___X___ No

3. Nature of Conveyance:

☒X___ Assignment ___ Merger
 ___ Security Agreement ___ Change of Name
 ___ Other _____

Execution Date in order of listed parties: 1/21/03; 1/29/03

4. Application number(s) or patent number(s).

___ This document is being filed together with a new application.

Execution date of the application in order of listed parties: 1/21/03; 1/29/03
 Title: Alignment Mark for e-Beam Inspection of a Semiconductor Wafer
 Docket No: TI-34307

A. Patent Application No.(s)
S.N. 10/288,990B. Patent No.(s)
6,435,398

Additional numbers attached? ___ Yes ___X___ No

Additional numbers attached? ___ Yes ___X___ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Jacqueline J. Garner
Texas Instruments Incorporated

Address: P.O. Box 655474, MS 3999

City: Dallas

State: TX Zip: 75265

6. Number of applications and patents involved: ___(1)___

7. Amount of fee enclosed or authorized to be charged: \$40

8. Deposit Account No: 20-0668 (Attach duplicate copy if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

2/18/03
Date

Gary C. Honeycutt, Reg. No. 20,250

Total Number of Pages Including Cover Sheet, Attachments and Document: 2

03/05/2003 T9IAZ1 00000066 200668 10288990

01 FC:8021 40.00 CH

PATENT
REEL: 013800 FRAME: 0472

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and


WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Alignment Mark for e-Beam Inspection of a Semiconductor Wafer		
SIGNATURE OF INVENTOR AND NAME	x Richard L. Guldi	x  Karanpreet Mahal	N/A
DATE OF SIGNATURE	x 1/21/03	x 1/29/03	
RESIDENCE (City, State)	Dallas, Texas	Richardson, Texas	
DATE APPLICATION EXECUTED			

After recording Assignment, please return to:

Jacqueline J. Garner
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265